

CCB 2554 Cancellation Notice: For the qualification of CuPdAu bond wire in selected products of the 90K and 120K wafer technologies available in 44L MQFP (10x10x2mm) package at ANAP assembly site.

Affected Catalog Part Numbers (CPN)

PCN_JAON-06WGQR202
CATALOG_PART_NBR
PIC16C64A-04/PQ
PIC16C64A-04I/PQ
PIC16C64A-10/PQ
PIC16C64A-20/PQ
PIC16C64A-20I/PQ
PIC16C64AT-04I/PQ
PIC16C64AT-10/PQ
PIC16C65A-04/PQ
PIC16C65A-04I/PQ
PIC16C65A-20/PQ
PIC16C65B-04/PQ
PIC16C65B-04I/PQ
PIC16C65B-20/PQ
PIC16C65B-20I/PQ
PIC16C67-04/PQ
PIC16C67-04I/PQ
PIC16C67-20/PQ
PIC16C67-20I/PQ
PIC16C67T-20I/PQ
PIC16C74A-04/PQ
PIC16C74A-04I/PQ
PIC16C74A-10/PQ
PIC16C74A-20/PQ
PIC16C74A-20E/PQ
PIC16C74A-20I/PQ
PIC16C74B-04/PQ
PIC16C74B-04I/PQ
PIC16C74B-20/PQ
PIC16C74B-20I/PQ
PIC16C77-04/PQ
PIC16C77-20/PQ
PIC16C774-I/PQ
PIC16F874-04/PQ
PIC16F874-04I/PQ
PIC16F874-20/PQ
PIC16F874-20I/PQ
PIC16F874T-04/PQ
PIC16F874T-04I/PQ
PIC16F874T-20/PQ
PIC16F877-04/PQ
PIC16F877-04E/PQ
PIC16F877-04I/PQ
PIC16F877-10E/PQ

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Affected Catalog Part Numbers (CPN)

PCN_JAON-06WGQR202
CATALOG_PART_NBR
PIC16F877-20/PQ
PIC16F877-20I/PQ
PIC16F877T-20I/PQ
PIC16LC64A-04I/PQ
PIC16LC65A-04/PQ
PIC16LC65B-04/PQ
PIC16LC65B-04I/PQ
PIC16LC67-04I/PQ
PIC16LC67T-04I/PQ
PIC16LC74A-04/PQ
PIC16LC74A-04I/PQ
PIC16LC74B-04/PQ
PIC16LC74B-04I/PQ
PIC16LC77-04/PQ
PIC16LC77-04I/PQ
PIC16LC774-I/PQ
PIC16LC774T-I/PQ
PIC16LF874-04I/PQ
PIC16LF877-04/PQ
PIC16LF877-04I/PQ
PIC17C42A-16/PQ
PIC17C42A-16I/PQ
PIC17C42A-25/PQ
PIC17C42A-33/PQ
PIC17C43-16/PQ
PIC17C43-25/PQ
PIC17C43-33/PQ
PIC17C43-33I/PQ
PIC17C44-16/PQ
PIC17C44-16I/PQ
PIC17C44-25/PQ
PIC17C44-25I/PQ
PIC17LC44-08/PQ
PIC17LC44-08I/PQ
PIC17LC44T-08I/PQ